



10A -1200V SiC Schottky Diode

Rev. B, April 2020

DATASHEET

UJ3D1210K2

Description

UnitedSiC offers the 3rd generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175°C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.



Features

- Maximum operating temperature of 175°C
- Easy paralleling
- Extremely fast switching not dependent on temperature
- No reverse or forward recovery
- Enhanced surge current capability, MPS structure
- 100% UIS tested
- AEC-Q101 qualified

Typical applications

- Power converters
- Industrial motor drives
- Switch mode power supplies
- Power factor correction modules

| Part Number | Package | Marking |
|-------------|-----------|------------|
| UJ3D1210K2 | TO-247-2L | UJ3D1210K2 |







Maximum Ratings

| Parameter | Symbol | Test Conditions | Value | Units | |
|---|-----------------------------------|--|------------|--------------------|--|
| DC blocking voltage | V _R | | 1200 | V | |
| Repetitive peak reverse voltage, T _J =25°C | V _{RRM} | | 1200 | V | |
| Surge peak reverse voltage | V _{RSM} | | 1200 | V | |
| Maximum DC forward current | I _F | T _C = 146°C | 10 | А | |
| Non-repetitive forward surge current | I _{FSM} | T _C = 25°C, t _p = 10ms | 120 | • | |
| sine halfwave | | T _C = 110°C, t _p = 10ms | 110 | A | |
| Repetitive forward surge current | | T _C = 25°C, t _p = 10ms | 39.4 | А | |
| sine halfwave, D=0.1 | I _{FRM} | T _C = 110°C, t _p = 10ms | 24 | | |
| Non-repetitive peak forward current | I _{F,max} | T _C = 25°C, t _p = 10μs | 720 | А | |
| | | T _C = 110°C, t _p = 10μs | 720 | | |
| •2. | ∫i²dt — | $T_{c} = 25^{\circ}C, t_{p} = 10ms$ | 72 | – A ² s | |
| i ² t value | | $T_{\rm C} = 110^{\circ}{\rm C}, t_{\rm p} = 10{\rm ms}$ | 60 | | |
| Power dissipation | P _{tot} — | T _C = 25°C | 136.4 | 14/ | |
| | | T _C = 146°C | 26.4 | W | |
| Maximum junction temperature | T _{J,max} | | 175 | °C | |
| Operating and storage temperature | T _J , T _{STG} | | -55 to 175 | °C | |
| Soldering temperatures, wavesoldering only allowed at leads | T _{sold} | 1.6mm from case for 10s | 260 | °C | |

Thermal Characteristics

| Parameter | Symbol | Test Conditions | Value | | | Units |
|--------------------------------------|-----------------|-----------------|-------|------|-----|-------|
| | | | Min | Тур | Max | Units |
| Thermal resistance, junction-to-case | $R_{\theta JC}$ | | | 0.83 | 1.1 | °C/W |



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Electrical Characteristics (T_J = +25°C unless otherwise specified)

| Parameter | Symbol | Test Conditions | Value | | | L locito |
|--|----------------|--|-------|------|-----|----------|
| | | | Min | Тур | Max | - Units |
| Forward voltage | V _F | I _F = 10A, T _J =25°C | - | 1.4 | 1.6 | V |
| | | I _F = 10A, T _J =150°C | - | 1.85 | 2.3 | |
| | | I _F = 10A, T _J =175°C | - | 2 | 2.6 | |
| Devices a summer t | I _R | V _R =1200V, T _J =25°C | - | 10 | 110 | μΑ |
| Reverse current | | V _R =1200V, T _J =175°C | - | 450 | | |
| Total capacitive charge ⁽¹⁾ | Q _C | V _R =800V | | 51 | | nC |
| | С | V_R =1V, f = 1MHz | | 510 | | pF |
| Total capacitance | | V _R =400V, f = 1MHz | | 48 | | |
| | | V _R =800V, f = 1MHz | | 41 | | |
| Capacitance stored energy | E _C | V _R =800V | | 15 | | μJ |

(1) Q_c is independent on T_J , di_F/dt , and I_F as shown in the application note USCi_AN0011.

Typical Performance Diagrams



Figure 1. Typical forward characteristics



Figure 2. Typical forward characteristics in surge current





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Figure 3. Typical reverse characteristics

Figure 4. Power dissipation



Figure 5. Diode forward current

Figure 6. Maximum transient thermal impedance







Figure 7. Capacitance vs. reverse voltage at 1MHz



Figure 8. Typical capacitive charge vs. reverse voltage



Figure 9. Typical capacitance stored energy vs. reverse voltage









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